SN74CBT16211C 24-BIT FET BUS SWITCH 5-V BUS SWITCH WITH –2-V UNDERSHOOT PROTECTION SCDS116C – JANUARY 2003 – REVISED OCTOBER 2003

•	Member of the Texas Instruments Widebus™ Family	DGG, DO		R DL PA VIEW)	ACKAGE
٠	Undershoot Protection for Off-Isolation on A and B Ports Up To –2 V	NC [1A1 [] 1 <u>0E</u>] 20E
٠	Bidirectional Data Flow, With Near-Zero Propagation Delay	1A2 [1A3 [3	54] 1B1] 1B2
٠	Low ON-State Resistance (r_{on}) Characteristics (r_{on} = 3 Ω Typical)	1A4 [1A5 [5	52] 1B3] 1B4
•	Low Input/Output Capacitance Minimizes Loading and Signal Distortion	1A6 [GND [8	49]1B5]GND
•	(C _{io(OFF)} = 5.5 pF Typical) Data and Control Inputs Provide	1A7 L 1A8 [1A9 [10	47	1B6 1B7 1B8
•	Undershoot Clamp Diodes Low Power Consumption	1A10 1A11	12	45	1B9 1B10
•	(I _{CC} = 3 μA Max) V _{CC} Operating Range From 4 V to 5.5 V	1A12 2A1	15	42] 1B11] 1B12
•	Data I/Os Support 0 to 5-V Signaling Levels (0.8-V, 1.2-V, 1.5-V, 1.8-V, 2.5-V, 3.3-V, 5-V)	2A2 V _{CC} [17	40	2B1 2B2
•	Control Inputs Can Be Driven by TTL or 5-V/3.3-V CMOS Outputs	2A3 [GND [19	38]2B3]GND
•	I _{off} Supports Partial-Power-Down Mode Operation	2A4 2A5 2A6	21	36	2B4 2B5 2B6
•	Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II	2A6 L 2A7 [2A8 [23	34	2B7 2B7 2B8
•	ESD Performance Tested Per JESD 22 – 2000-V Human-Body Model	2A9 [2A9 [2A10 [25	32	2B0 2B9 2B10
	(A114-B, Class II) – 1000-V Charged-Device Model (C101)	2A11 [2A12 [27		2B11 2B12
•	Supports Both Digital and Analog Applications: PCI Interface, Memory	NC – N	lo inte	rnal co	nnection

description/ordering information

Signal Gating

Interleaving, Bus Isolation, Low-Distortion

TA PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING					
	SSOP – DL	Tube	SN74CBT16211CDL	CBT16211C				
	Tape and re	Tape and reel	SN74CBT16211CDLR	CBI16211C				
$-40^{\circ}C$ to $85^{\circ}C$		Tube	SN74CBT16211CDGG	CBT16211C				
	1330F - DGG	Tape and reel	SN74CBT16211CDGGR	CBTI02TIC				
	TVSOP – DGV	Tape and reel	SN74CBT16211CDGVR	CY211C				

ORDERING INFORMATION

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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description/ordering information (continued)

The SN74CBT16211C is a high-speed TTL-compatible FET bus switch with low ON-state resistance (ron), allowing for minimal propagation delay. Active Undershoot-Protection Circuitry on the A and B ports of the SN74CBT16211C provides protection for undershoot up to -2 V by sensing an undershoot event and ensuring that the switch remains in the proper OFF state.

The SN74CBT16211C is organized as two 12-bit bus switches with separate output-enable (1OE, 2OE) inputs. It can be used as two 12-bit bus switches or as one 24-bit bus switch. When \overline{OE} is low, the associated 12-bit bus switch is ON, and the A port is connected to the B port, allowing bidirectional data flow between ports. When OE is high, the associated 12-bit bus switch is OFF, and the high-impedance state exists between the A and B ports.

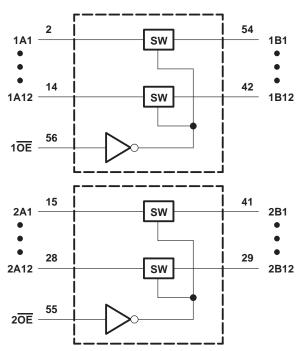
This device is fully specified for partial-power-down applications using Ioff. The Ioff feature ensures that damaging current will not backflow through the device when it is powered down. The device has isolation during power off.

To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

INPUT OE	INPUT/OUTPUT A	FUNCTION				
L	В	A port = B port				
Н	Z	Disconnect				

FUNCTION TABLE (each 12-bit bus switch)

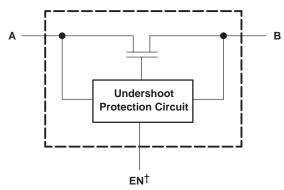
logic diagram (positive logic)





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simplified schematic, each FET switch (SW)



[†] EN is the internal enable signal applied to the switch.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltages are with respect to ground unless otherwise specified.
 - 2. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - 3. V_I and V_O are used to denote specific conditions for V_{I/O}.
 - 4. I and IO are used to denote specific conditions for I/O.
 - 5. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 6)

		MIN	MAX	UNIT
VCC	Supply voltage	4	5.5	V
VIH	High-level control input voltage	2	5.5	V
VIL	Low-level control input voltage	0	0.8	V
VI/O	Data input/output voltage	0	5.5	V
Τ _Α	Operating free-air temperature	-40	85	°C

NOTE 6: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER		TEST CONDITIC	ONS	MIN TYP [†]	MAX	UNIT
VIK	Control inputs	V _{CC} = 4.5 V,	I _{IN} = -18 mA			-1.8	V
VIKU	Data inputs	V _{CC} = 5 V,	0 mA > I _I \ge -50 mA, V _{IN} = V _{CC} or GND,	Switch OFF		-2	V
I _{IN}	Control inputs	V _{CC} = 5.5 V,	$V_{IN} = V_{CC} \text{ or } GND$			±1	μΑ
IOZ‡		V _{CC} = 5.5 V,	$V_{O} = 0$ to 5.5 V, $V_{I} = 0$,	Switch OFF, V _{IN} = V _{CC} or GND		±10	μA
loff		$V_{CC} = 0,$	$V_{O} = 0$ to 5.5 V,	$V_{\parallel} = 0$		10	μΑ
ICC		V _{CC} = 5.5 V,	I _{I/O} = 0, V _{IN} = V _{CC} or GND,	Switch ON or OFF		3	μA
∏ UCC§	Control inputs	V _{CC} = 5.5 V,	One input at 3.4 V,	Other inputs at V_{CC} or GND		2.5	mA
Cin	Control inputs	V _{IN} = 3 V or 0			4.5		pF
Cio(OFF	=)	$V_{I/O} = 3 V \text{ or } 0,$	Switch OFF,	$V_{IN} = V_{CC}$ or GND	5.5		pF
Cio(ON))	V _{I/O} = 3 V or 0,	Switch ON,	$V_{IN} = V_{CC}$ or GND	14.5		pF
ron¶		$V_{CC} = 4 V$, TYP at $V_{CC} = 4 V$	V ₁ = 2.4 V,	I _O = -15 mA	8	12	
				I _O = 64 mA	3	6	Ω
		V _{CC} = 4.5 V	$V_{I} = 0$	I _O = 30 mA	3	6	
			V _I = 2.4 V,	I _O = -15 mA	5	10	

 V_{IN} and I_{IN} refer to control inputs. V_I , V_O , I_I , and I_O refer to data pins.

[†] All typical values are at V_{CC} = 5 V (unless otherwise noted), T_A = 25°C.

[‡] For I/O ports, the parameter I_{OZ} includes the input leakage current.

This is the increase in supply current for each input that is at the specified voltage level, rather than V_{CC} or GND.

¶ Measured by the voltage drop between the A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

Γ	PARAMETER	FROM	TO	V _{CC} =	= 4 V	= V _{CC} ± 0.	= 5 V 5 V	UNIT
		(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	
	^t pd [#]	A or B	B or A		0.24		0.15	ns
	ten	OE	A or B		6.5	1.5	6	ns
	^t dis	OE	A or B		6.5	1.5	6	ns

[#] The propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).



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undershoot characteristics (see Figures 1 and 2)

	TEST CONDITIONS	MIN	TYPŤ	MAX	UNIT
νουτυ νοα		2	V _{OH} -0.3		V

[†] All typical values are at V_{CC} = 5 V (unless otherwise noted), T_A = 25°C.

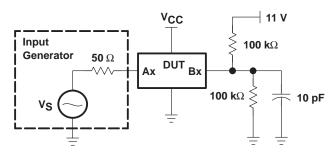


Figure 1. Device Test Setup

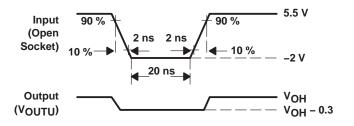
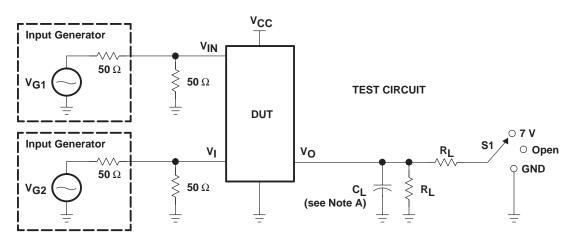


Figure 2. Transient Input Voltage (V_I) and Output Voltage (V_{OUTU}) Waveforms (Switch OFF)



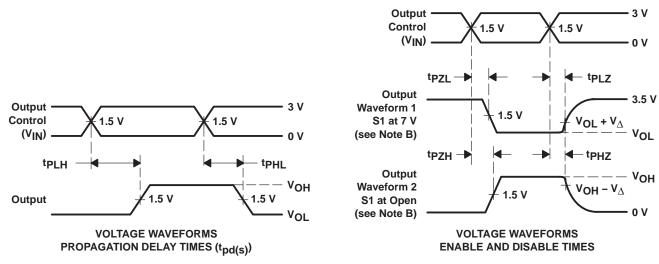
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PARAMETER MEASUREMENT INFORMATION

TEST	VCC	S1	RL	VI	CL	v_Δ
^t pd(s)	$\begin{array}{c} 5 \text{ V} \pm 0.5 \text{ V} \\ 4 \text{ V} \end{array}$	Open Open	500 Ω 500 Ω	V _{CC} or GND V _{CC} or GND	50 pF 50 pF	
tPLZ/tPZL	$\begin{array}{c} 5 \text{ V} \pm 0.5 \text{ V} \\ 4 \text{ V} \end{array}$	7 V 7 V	500 Ω 500 Ω	GND GND	50 pF 50 pF	0.3 V 0.3 V
^t PHZ ^{/t} PZH	$\begin{array}{c} 5 \text{ V} \pm 0.5 \text{ V} \\ 4 \text{ V} \end{array}$	Open Open	500 Ω 500 Ω	VCC VCC	50 pF 50 pF	0.3 V 0.3 V



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_Q = 50 Ω , t_f \leq 2.5 ns, t_f \leq 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. tPZL and tPZH are the same as ten.
- G. tpLH and tpHL are the same as tpd(s). The tpd propagation delay is the calculated RC time constant of the typical ON-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).
- H. All parameters and waveforms are not applicable to all devices.





MECHANICAL DATA

PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

DGV (R-PDSO-G**)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



MECHANICAL DATA

MSSO001C - JANUARY 1995 - REVISED DECEMBER 2001

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN

DL (R-PDSO-G**)



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118



MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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